IRF530

Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>a</sub> max. (nC)

Configuration

# **Power MOSFET**

S

N-Channel MOSFET

0.16

100

26

5.5

11

Single

 $V_{GS} = 10 V$ 

## FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF530PbF
Lead (Pb)-free and halogen-free	IRF530PbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)									
PARAMETER			SYMBOL	LIMIT	UNIT				
Drain-source voltage			V <sub>DS</sub>	100	Ň				
Gate-source voltage			V <sub>GS</sub>	± 20	V				
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		14					
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	10	А				
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	56	1				
Linear derating factor				0.59	W/°C				
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	69	mJ				
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	14	А				
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ				
Maximum power dissipation	T <sub>C</sub> =	25 °C	PD	88	W				
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns				
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C				
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300					
Mounting torque	6-32 or M3 screw			10	lbf ∙ in				
			-	1.1	N · m				

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 528 µH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 14 A (see fig. 12)

c.  $I_{SD} \le 14$  A, dI/dt  $\le 140$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62				
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50 -				°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 1.7						
	•							
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static						•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 2	50 µA	100	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, l	l <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{0}$	<sub>GS</sub> , I <sub>D</sub> = 2	50 µA	2.0	-	4.0	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>G</sub>	V <sub>GS</sub> = ± 20 V			-	± 100	nA
Zero gate voltage drain current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			-	-	25	
	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>0</sub>	<sub>GS</sub> = 0 V, '	T <sub>J</sub> = 150 °C	-	-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 8.4 A <sup>b</sup>	-	-	0.16	Ω
Forward transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = 50	0 V, I <sub>D</sub> = 8	8.4 A <sup>b</sup>	5.1	-	-	S
Dynamic						•	•	
Input capacitance	C <sub>iss</sub>	V	a = 0 V		-	670	-	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	250	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	60	-		
Total gate charge	Qg				-	-	26	nC
Gate-source charge	$Q_gs$	$V_{GS} = 10 V$		<sub>D</sub> = 14 A, V <sub>DS</sub> = 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	5.5	
Gate-drain charge	Q <sub>gd</sub>				-	-	11	
Turn-on delay time	t <sub>d(on)</sub>				-	10	-	
Rise time	t <sub>r</sub>	$V_{DD}$ = 50 V, I_D = 14 A $R_g$ = 12 $\Omega,R_D$ = 3.6 $\Omega,see$ fig. 10 $^{\rm b}$		-	34	-	ns	
Turn-off delay time	t <sub>d(off)</sub>			-	23	-		
Fall time	t <sub>f</sub>				-	24	-	1
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain			1.0	-	4.7	Ω
Internal drain inductance	L <sub>D</sub>	6 mm (0.25") fr	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal source inductance	Ls	die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs					•	•	1
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the		-	-	14	A	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	p - n junction diode			-	-		56
Body diode voltage	V <sub>SD</sub>	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 14 A, $V_{\rm GS}$ = 0 V <sup>b</sup>			-	-	2.5	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 14 \text{ A}, dl/dt = 100 \text{ A/}\mu\text{s}^{b}$ Intrinsic turn-on time is negligible (turn			-	150	280	ns
Body diode reverse recovery charge	Q <sub>rr</sub>				-	0.85	1.7	μC
Forward turn-on time	t <sub>on</sub>				on is do	minated b	by L <sub>S</sub> and	and L <sub>D</sub> )

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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Document Number: 91019

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

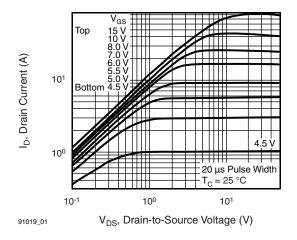


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

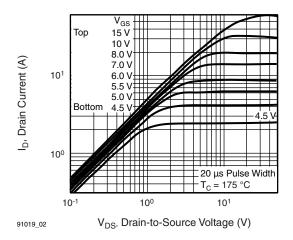
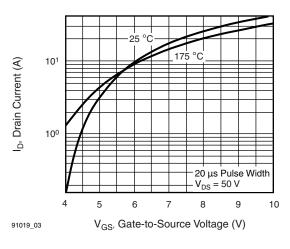


Fig. 2 - Typical Output Characteristics,  $T_C = 175 \ ^{\circ}C$ 





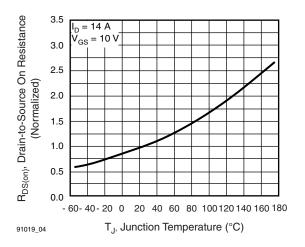


Fig. 4 - Normalized On-Resistance vs. Temperature

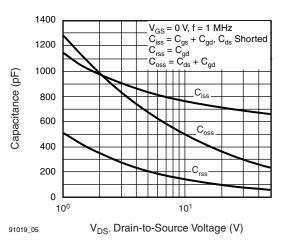


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

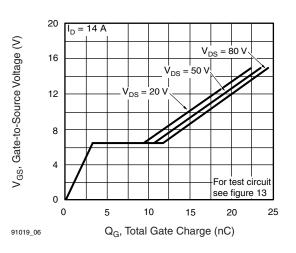


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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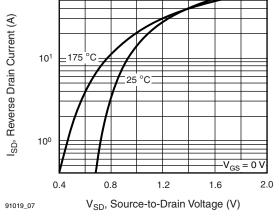


Fig. 7 - Typical Source-Drain Diode Forward Voltage

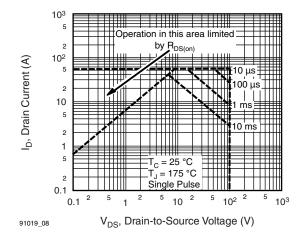


Fig. 8 - Maximum Safe Operating Area

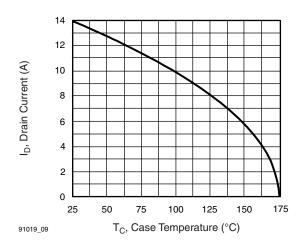


Fig. 9 - Maximum Drain Current vs. Case Temperature

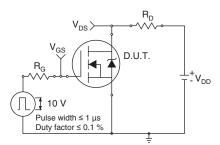


Fig. 10a - Switching Time Test Circuit

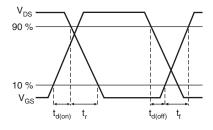


Fig. 10b - Switching Time Waveforms

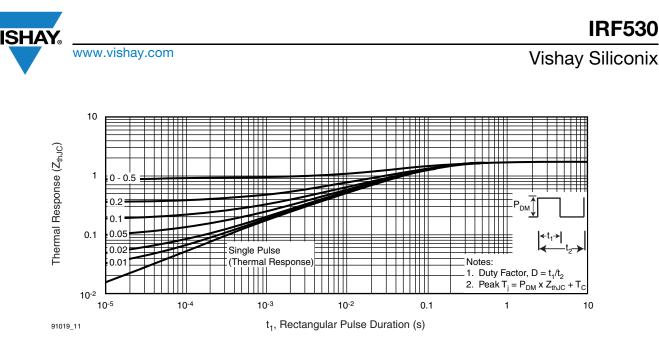


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

V<sub>DS</sub>

I<sub>AS</sub>

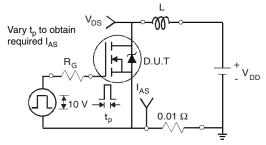


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

/<sub>DS</sub>

 $V_{DD}$ 

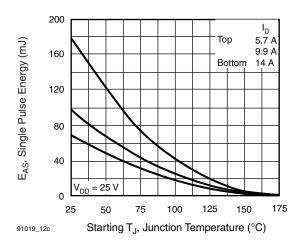


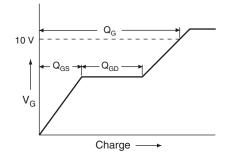
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

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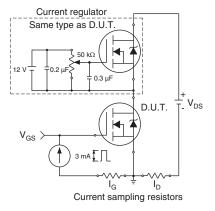
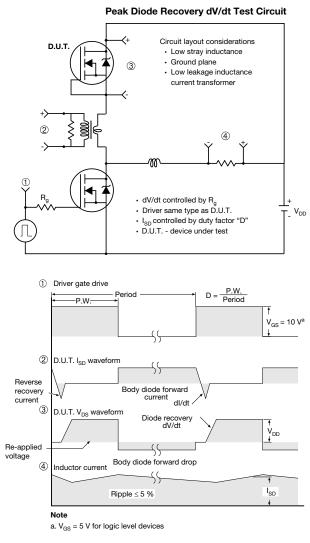


Fig. 13a - Basic Gate Charge Waveform





#### Fig. 14 - For N-Channel

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Revision: 01-Jan-2024